

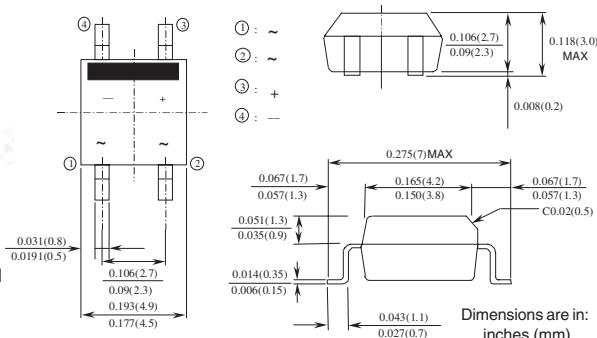
## MB1S - MB8S

### Features

- Low leakage
- Surge overload rating: 35 amperes peak.
- Ideal for printed circuit board.



**SOIC-4**  
Polarity symbols molded or marking on body



## 0.5 Ampere Glass Passivated Bridge Rectifiers

### Absolute Maximum Ratings\*

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Value	Units
$I_o$	Average Rectified Current $\text{@ } T_A = 50^\circ\text{C}$	0.5	A
$i_f(\text{surge})$	Peak Forward Surge Current 8.3 ms single half-sine-wave Superimposed on rated load (JEDEC method)	35	A
$P_D$	Total Device Dissipation Derate above $25^\circ\text{C}$	1.4 11	mW/ $^\circ\text{C}$
$R_{JA}$	Thermal Resistance, Junction to Ambient,** per leg	85	$^\circ\text{C/W}$
$R_{JL}$	Thermal Resistance, Junction to Lead,** per leg	20	$^\circ\text{C/W}$
$T_{stg}$	Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature	-55 to +150	$^\circ\text{C}$

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

\*\*Device mounted on PCB with 0.5-0.5" (13x13 mm) lead length.

### Electrical Characteristics

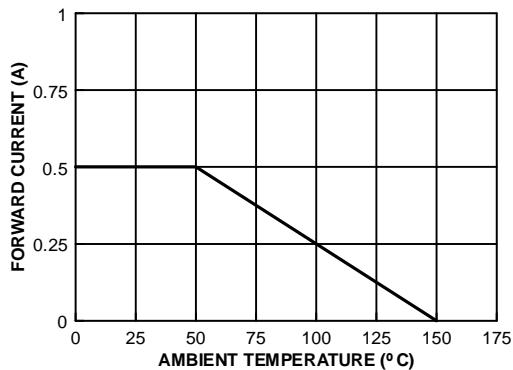
$T_A = 25^\circ\text{C}$  unless otherwise noted

Parameter	Device					Units
	1S	2S	4S	6S	8S	
Peak Repetitive Reverse Voltage	100	200	400	600	800	V
Maximum RMS Bridge Input Voltage	70	140	280	420	560	V
DC Reverse Voltage (Rated $V_R$ )	100	200	400	600	800	V
Maximum Reverse Leakage, per leg @ rated $V_R$ $T_A = 25^\circ\text{C}$ $T_A = 125^\circ\text{C}$			5.0 0.5			A mA
Maximum Forward Voltage Drop, per bridge @ 0.5 A			1.0			V
$I^2t$ rating for fusing $t < 8.3 \text{ ms}$			5.0			$\text{A}^2\text{t}$
Typical Junction Capacitance, per leg $V_R = 4.0 \text{ V}, f = 1.0 \text{ MHz}$			13			pF

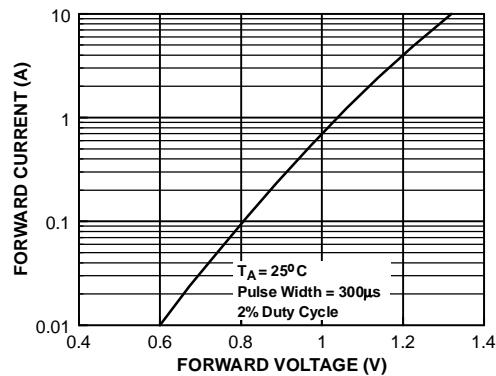
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## Typical Characteristics

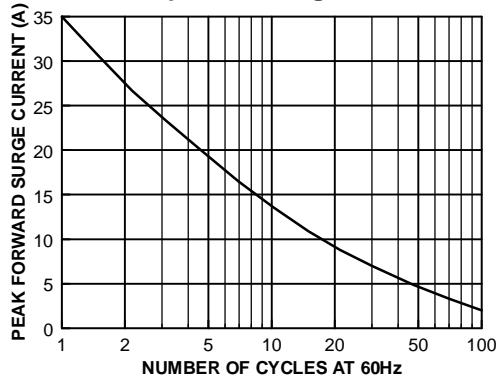
**Forward Current Derating Curve**



**Forward Characteristics**



**Non-Repetitive Surge Current**



**Reverse Characteristics**

